



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(ON) Max	I _D T _A = +25°C
-40V	11mΩ @ V _{GS} = -10V	-10.1A
-40V	15mΩ @ V _{GS} = -4.5V	-8.8A

Description and Application

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- DC-DC converters
- Power management functions
- Analog switches

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

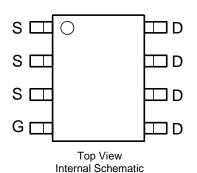
https://www.diodes.com/quality/product-definitions/

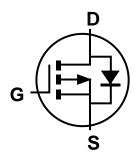
An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMP4015SSSQ</u>)

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.074 grams (Approximate)







Equivalent circuit

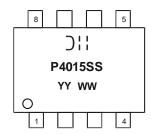
Ordering Information (Note 4)

Part Number	Package	Packing		
	Package	Qty.	Carrier	
DMP4015SSS-13	SO-8	2,500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking P4015SS = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 22 = 2022) WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-40	V		
Gate-Source Voltage			Vgss	±25	V
Continuous Drain Current (Note 5) V _{GS} = -10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lD	-9.1 -7.2	А
Continuous Drain Current (Note 5) VGS = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	-7.8 -6.2	А
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	ID	-10.1 -8	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	-8.8 -7	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	-100	Α		
Avalanche Current (Note 7)			I _{AS}	-22	Α
Avalanche Energy (Note 7)			Eas	242	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	1.45	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	88	°C/W
Total Power Dissipation (Note 6)	PD	1.82	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	70	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{θJc}	7.6	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

 ${\it 5. \ Device mounted on FR-4 \ PC \ board, with \ minimum \ recommended \ pad \ layout, \ single \ sided.}$ Notes:

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.

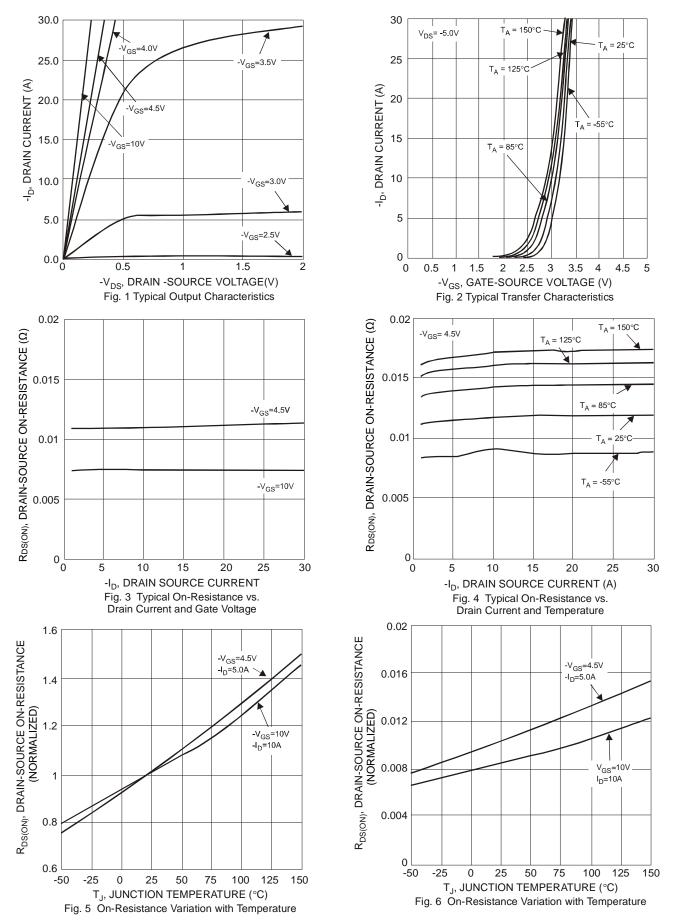
7. UIS in production with L = 1mH, $T_J = +25$ °C.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

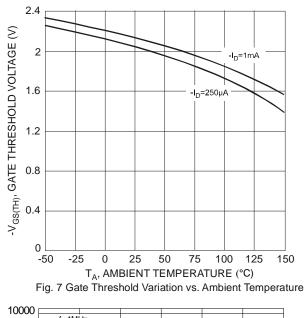
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$V_{GS} = 0V$, $I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	1	_	-1	μA	V _{DS} = -40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	1	_	±100	nA	$V_{GS} = \pm 25V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(TH)	-1.5	-2	-2.5	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
Static Drain-Source On-Resistance	D- a (a) ii	_	7	11	mΩ	$V_{GS} = -10V, I_D = -9.8A$
Static Dialif-Source Off-Nesistance	R _{DS(ON)}	1	9	15	11122	$V_{GS} = -4.5V$, $I_D = -9.8A$
Forward Transfer Admittance	Y _{fs}	-	26	_	S	V _{DS} = -20V, I _D = -9.8A
Diode Forward Voltage (Note 5)	VsD	1	-0.7	-1	V	Vgs = 0V, Is = -1A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	4234	_		$V_{DS} = -20V$, $V_{GS} = 0V$ f = 1MHz
Output Capacitance	Coss	-	1036	_	pF	
Reverse Transfer Capacitance	Crss	_	526	_		
Gate Resistance	R_g	1	7.77	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg	-	47.5	_		V _{DS} = -20V, V _{GS} = -5V I _D = -9.8A
Gate-Source Charge	Qgs	-	14.2	_	nC	
Gate-Drain Charge	Q_{gd}	_	13.5	_		
Turn-On Delay Time	td(on)	1	13.2	_		$V_{GS} = -10V, \ V_{DD} = -20V, \ R_g = 6\Omega$ $I_D = -1A, \ R_L = 20\Omega$
Turn-On Rise Time	tR	-	10	_	ns	
Turn-Off Delay Time	tD(OFF)	_	302.7	_	115	
Turn-Off Fall Time	t _F	_	137.9	_		

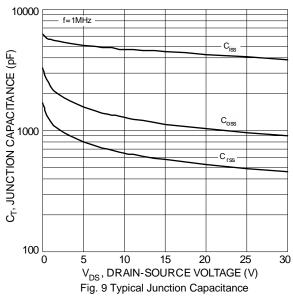
8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.

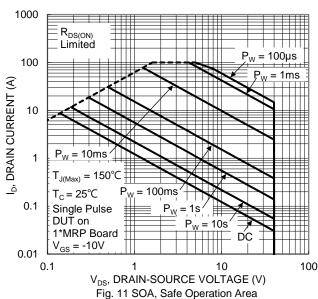


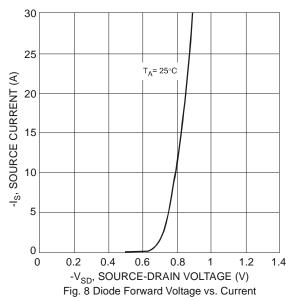


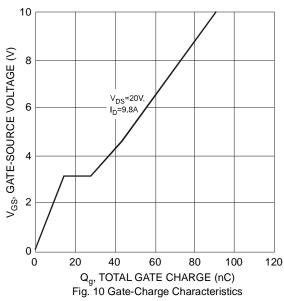


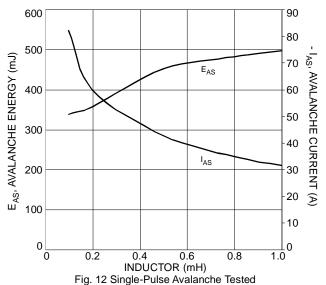




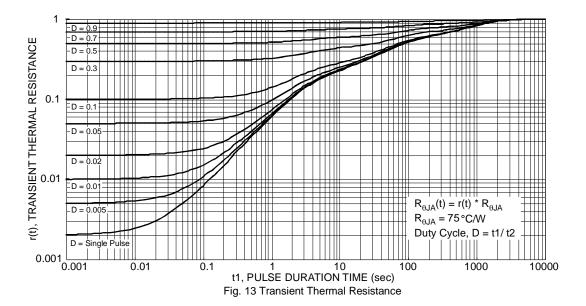










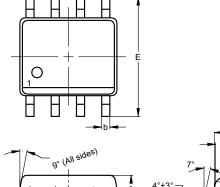


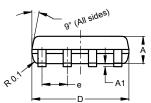


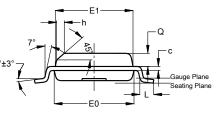
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8





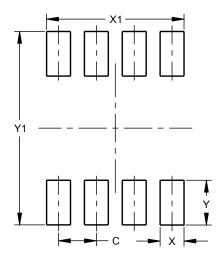


SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h	-		0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

July 2022



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